Properties of Al and Pd contacts on n-type SiC membranes

Abstract

Membranes with dimensions up to 10 mm x 15 mm have been fabricated in epitaxial 3C-SiC/Si wafers. An array of CTLM metal contacts was deposited onto the upper surface of the n-SiC membrane. Both Al/n-SiC and Pd/n-SiC contacts which were formed on the membrane and on the adjacent substrate have shown an ohmic current/ voltage response. Values of specific contact resistance, ρc , were measured directly on the membranes. These results have shown no consistent difference in ρc of the contacts located either on the membrane or off the membrane. The exposure of SiC surfaces to reactive ion etching in CF4 plasma during the fabrication of a membrane has resulted in ρc which was higher by a factor of 103 than with as-grown and KOH etched silicon surfaces.

Keywords — Metal contacts, ohmic currents, properties of Al, SiC membranes